

## **General Description**

The LB1117 is a low dropout three terminal regulator that features a low quiescent current, low input, output and dropout voltages, as well as over temperature shutdown. The output voltage of the LB1117 is set at the factory and trimmed to  $\pm 1\%$ . The LB1117 is stable with a aluminum electrolytic capacitor of 10uF.

This family of regulators can provide either a stand-alone power supply solution or act as a post regulator for switch mode power supplies. They are particularly well suited for applications requiring low input and output voltage.

## **Features**

- Min. 1.1A Output Current Limiter
- 1.4V Maximum Full load Dropout Voltage
- 3-Terminal Adjustable or Fixed , 1.5V, 1.8V, 2.5V, 3.3V and 5V Output Voltage
- Fast Load Transient Response
- Built-in Over Current Protection
- Built-in Over Temperature Protection
- Good Noise Rejection Capability
- Stable with Aluminum Electrolytic Capacitor Cap of 10uF
- Package : SOT223-3L, SOT89-3L, TO252-3L
- RoHS Compliant & Halogen Free

## **Applications**

- PC Mother Board Applications
- LCD TV/ Monitors
- Communication Devices

Please be aware that an <b>Important Notice</b> concerning availability, disclaimers, and use in critical applications of LSC products is at the end of this document.
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**Block Diagram**

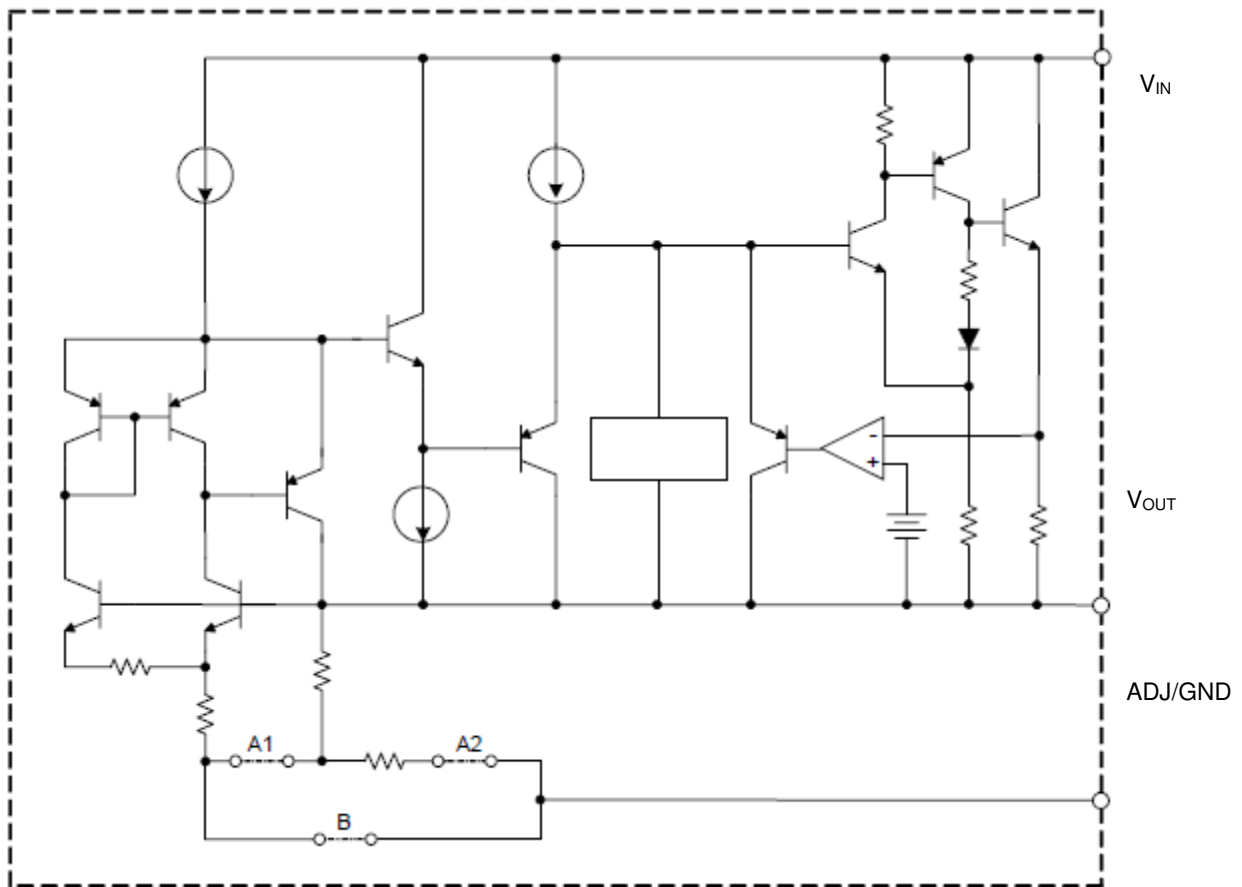
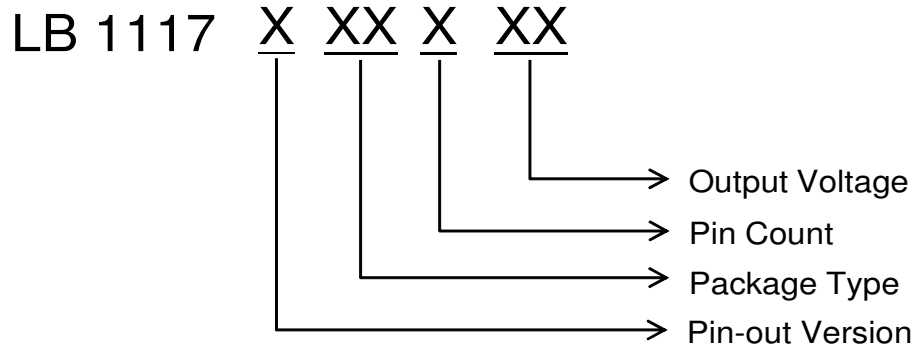


Figure 1 . Block Diagram

### Ordering Information



Pin-out Version		Package Type	Pin Count	Output Voltage
A	1. ADJ/GND	AD : SOT223	A : 2	ADJ : Adjustable
(SOT223-3L)	2. VOUT	AT : SOT89	B : 3	150 : 1.50V
(SOT89-3L)	3. VIN	AC : TO252		180 : 1.80V
(TO252-2L)				250 : 2.50V
				330 : 3.30V
				500 : 5.00V

**Pin Assignment**

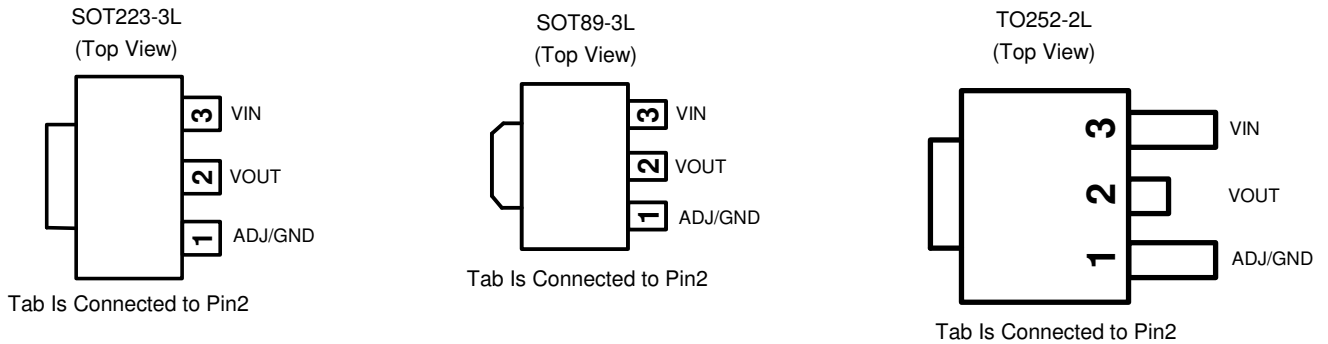


Figure 2. Pin Assignments

**Pin Descriptions**

Pin Name	Pin Description
ADJ/GND	Vo Adjusting Pin or Ground Pin
VOUT	Voltage Output
V/N	Voltage Input

**Absolute Maximum Ratings** (at  $T_A=25^{\circ}\text{C}$ )

Operate over the “Absolute Maximum Ratings” may cause permanent damage to the device. Exposure to such conditions for extended time may still affect the reliability of the device.

Parameter	Value
DC Supply Voltage	-0.3 ~ 20V
Power Dissipation	Internally Limited
Maximum Junction Temperature (note1)	150°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature	260°C, to 10 sec
ESD Withstand Voltage - Human Body Model (HBM) - Machine Model (MM)	2000V 200V
Moisture Sensitivity	Please Refer The Moisture Sensitivity Label on the IC packing bag material for more detail.

Note 1 : Maximum Junction Temperature is the temperature limit of this device. Over this limit, the IC may be damaged permanently. Operation Junction Temperature Range is the range the device intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, please refer the Electrical Characteristics

**Recommended Operating Conditions**

Characteristics	Symbol	Min	Max	Unit
Input Voltage	$V_{IN}$	$V_{OUT}+1.5V$	15	V
Output Current	$I_{OUT}$	10	1000	mA
Operating Junction Temperature Range	$T_J$	-40	125 (Note2)	°C

Note 2 : If the IC experienced OTP, then the temperature may need to drop to <125 °C to let the IC recover.

**Electrical Characteristics**

TA=25°C, C<sub>IN</sub>=C<sub>OUT</sub>=10μF aluminum electrolytic capacitance, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Reference Voltage	V <sub>REF</sub>	LB1117-ADJ V <sub>IN</sub> =V <sub>OUT</sub> + 1.5V, I <sub>OUT</sub> = 10mA	1.238	1.250	1.262	V
Output Voltage	V <sub>OUT</sub>	LB1117-1.5V 3V ≤ V <sub>IN</sub> ≤ 12V, I <sub>OUT</sub> = 10mA	1.485	1.500	1.515	V
		LB1117-1.8V 3.3V ≤ V <sub>IN</sub> ≤ 12V, I <sub>OUT</sub> = 10mA	1.782	1.800	1.818	
		LB1117-2.5V 4V ≤ V <sub>IN</sub> ≤ 12V, I <sub>OUT</sub> = 10mA	2.475	2.500	2.525	
		LB1117-3.3V 4.8V ≤ V <sub>IN</sub> ≤ 12V, I <sub>OUT</sub> = 10mA	3.267	3.300	3.333	
		LB1117-5.0V 6.5V ≤ V <sub>IN</sub> ≤ 12V, I <sub>OUT</sub> = 10mA	4.950	5.000	5.05	
Line Regulation (=Δ V <sub>OUT</sub> /Δ V <sub>IN</sub> )	ΔV <sub>OUT</sub>	LB1117- ADJ/1.5V/1.8V/2.5V/3.3V/5.0V V <sub>OUT</sub> +1.5V < V <sub>IN</sub> < 7V, I <sub>OUT</sub> = 10mA (Note 3)	-	0.1	0.3	%
		LB1117- ADJ/1.5V/1.8V/2.5V/3.3V/5.0V V <sub>OUT</sub> +1.5V < V <sub>IN</sub> < 12V, I <sub>OUT</sub> = 10mA (Note 3)	-	0.1	0.5	%
Load Regulation (=Δ V <sub>OUT</sub> )	V <sub>OUT</sub>	LB1117-ADJ V <sub>IN</sub> = V <sub>OUT</sub> +1.5V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	-	1	%
		LB1117-1.5V V <sub>IN</sub> = 3.0V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	12	15	mV
		LB1117-1.8V V <sub>IN</sub> = 3.3V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	15	18	mV
		LB1117-2.5 V V <sub>IN</sub> = 4.0V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	20	25	mV
		LB1117-3.3 V V <sub>IN</sub> = 5.0V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	26	33	mV
		LB1117-5.0 V V <sub>IN</sub> = 8.0V, 10mA < I <sub>OUT</sub> < 1A (Note 3)	-	40	50	mV
Dropout Voltage	V <sub>DO</sub>	LB1117- ADJ/1.5V/1.8V/2.5V/3.3V/5.0V I <sub>OUT</sub> = 0.8A, ΔV <sub>OUT</sub> = V <sub>OUT</sub> X 1% 0°C ≤ T <sub>J</sub> ≤ 125°C	-	1.3	1.4	V
Output Current Limit (Note4)	I <sub>LIMIT</sub>	LB1117- ADJ/1.5V/1.8V/2.5V/3.3V/5.0V (V <sub>IN</sub> -V <sub>OUT</sub> ) = 2V	1100	-	-	mA
Minimum Required Load Current	I <sub>L(min)</sub>	LB1117- ADJ/1.5V/1.8V/2.5V/3.3V/5.0V 0°C ≤ T <sub>J</sub> ≤ 125°C	-	5	10	mA
Adjust Pin Current	I <sub>ADJ</sub>	LB1117-ADJ, V <sub>IN</sub> =V <sub>OUT</sub> +1.5V, I <sub>OUT</sub> =10mA	-	50	120	uA

**Electrical Characteristics (Contd.)**

TA=25°C, C<sub>IN</sub>=C<sub>OUT</sub>=10μF aluminum electrolytic capacitance, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Adjust Pin Current Change	ΔI <sub>ADJ</sub>	LB1117-ADJ V <sub>IN</sub> =V <sub>OUT</sub> +1.5V to V <sub>IN</sub> =12V, I <sub>OUT</sub> =10mA to 800mA	-	4	7	uA
Ripple Rejection (Note 4)	PSRR	V <sub>IN</sub> =5V, V <sub>OUT</sub> =1.25V, I <sub>OUT</sub> =0.01A, 120 Hz sine wave, C <sub>OUT</sub> =10uF aluminum electrolytic Cap.	-	70	-	dB
RMS Output Noise (% of V <sub>OUT</sub> ) (Note 4)	e <sub>N</sub>	10Hz ≤ f ≤ 10 kHz	-	0.003	-	%
V <sub>OUT</sub> Temperature Coefficient (Note 4)	T <sub>C</sub>	TA = 25°C, 30ms Pulse	-	100	-	ppm/°C
Thermal Shutdown (Note 4)	T <sub>SD</sub>		-	150	-	°C
Thermal Shutdown Hysteresis	T <sub>SD(Hys)</sub>		-	25	-	°C

Note 3 : Line and load regulation are measured by low duty cycle pulse testing and the junction temperature is kept at 25 degree C. The V<sub>OUT</sub> of load regulation is measured at the out lead.

Note 4 : Guarantee by design. Not 100% tested in manufacturing.

**Application Circuit**

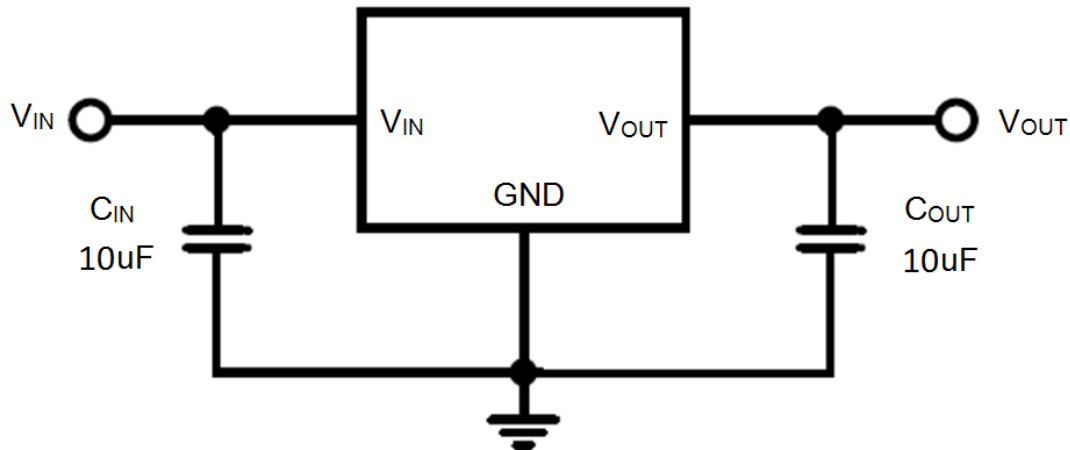


Figure 3(a). Typical Application Circuit – Fixed Output Versions

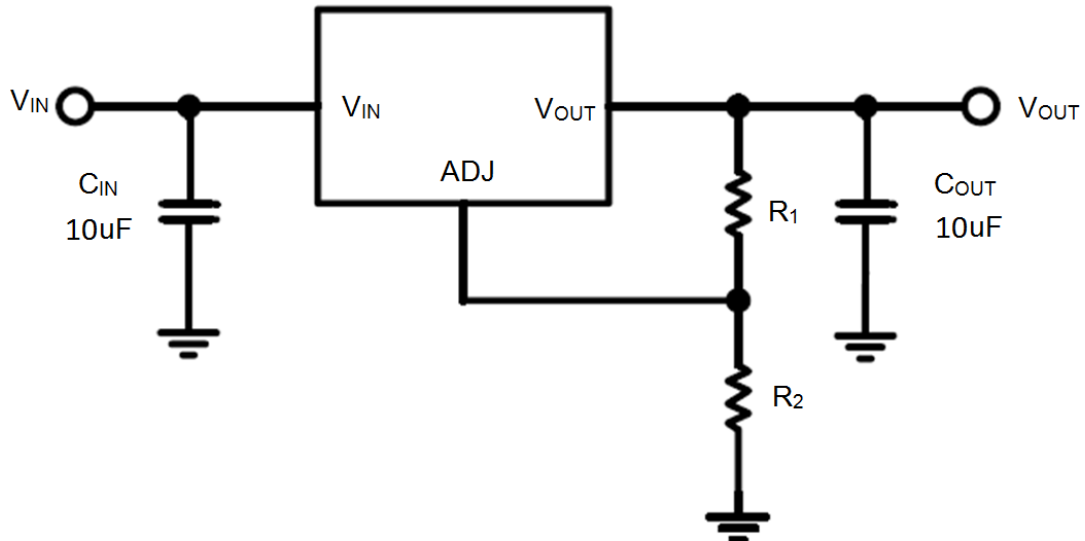
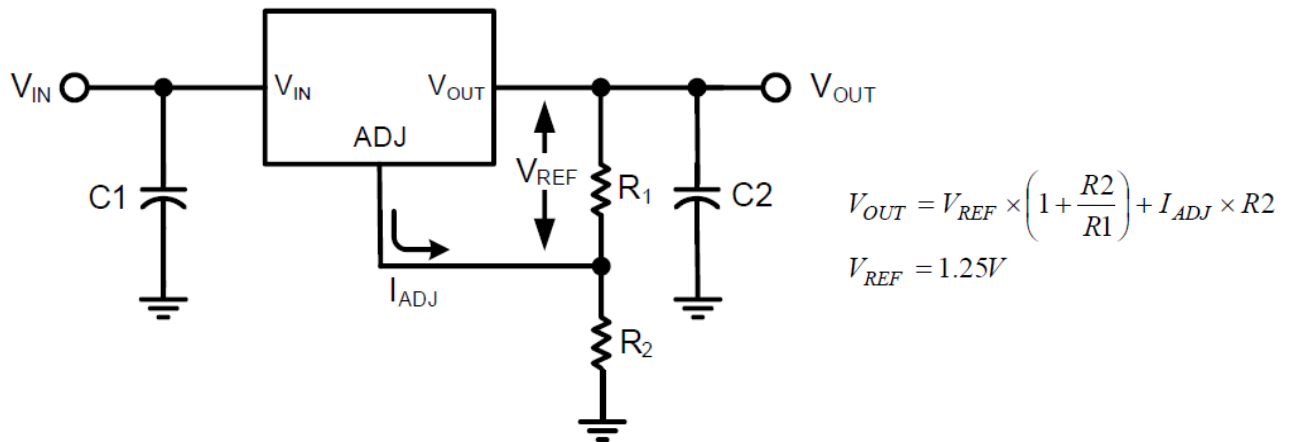


Figure 3(b). Typical Application Circuit – Adjustable Output Version

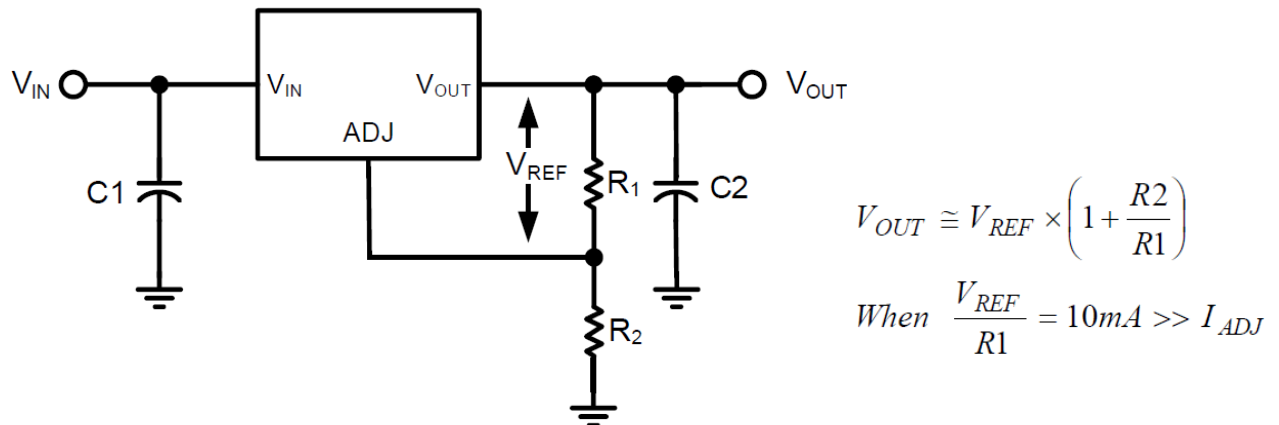
The LB1117 keeps a constant 1.25V between the output pin and the adjust pin. By placing a resistor  $R_1$  across these two pins a constant current flows through  $R_1$ , adding to the  $I_{ADJ}$  current and into the  $R_2$  resistor producing a voltage equal to the  $(1.25/R_1) \cdot R_2 + I_{ADJ} \cdot R_2$  which will be added to the 1.25V to set the output voltage.



### Application Circuit (Contd.)

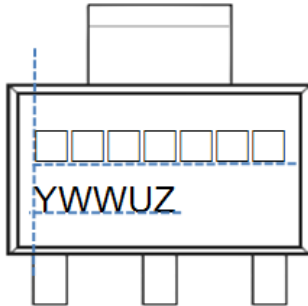


This is summarized in the above equation. Since the minimum load current requirement of the LB1117 is 10mA, R<sub>1</sub> is typically selected to be 121Ω resistor so that it automatically satisfies the minimum current requirement. Notice that since I<sub>ADJ</sub> is typically in the range of 50uA it only adds a small error to the output voltage and should only be considered when a very precise output voltage setting is required. For example, in a typical 3.3V application where R<sub>1</sub>=121Ω and R<sub>2</sub>=200Ω. The C<sub>1</sub>, C<sub>2</sub> capacitor are 10uF (Aluminum electrolytic capacitor).



**Marking Information**

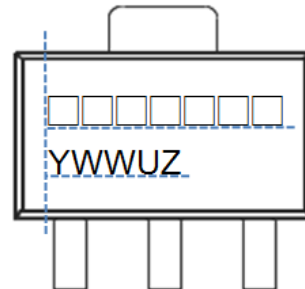
(1) SOT223-3L



- 1) □□□□□□ = Marking Name  
 B1117B2= LB1117AADB150  
 B1117B3= LB1117AADB180  
 B1117B4= LB1117AADB250  
 B1117B5= LB1117AADB330  
 B1117B6= LB1117AADB500  
 B1117B7= LB1117AADBADJ

- 2) YWWUZ = Date Code & Internal Code  
 Y = Year  
 WW = Week  
 UZ = Internal Code

(2) SOT89-3L

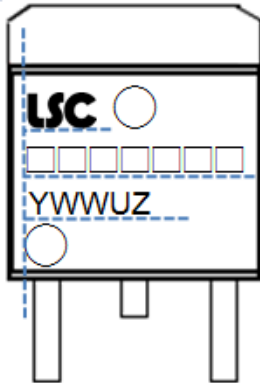


- 1) □□□□□□ = Marking Name  
 B1117T2= LB1117AATB150  
 B1117T3= LB1117AATB180  
 B1117T4= LB1117AATB250  
 B1117T5= LB1117AATB330  
 B1117T6= LB1117AATB500  
 B1117T7= LB1117AATBADJ

- 2) YWWUZ = Date Code & Internal Code  
 Y = Year  
 WW = Week  
 UZ = Internal Code

**Marking Information (Contd.)**

(3)T0252-2L



1) □□□□□□□ = Marking Name

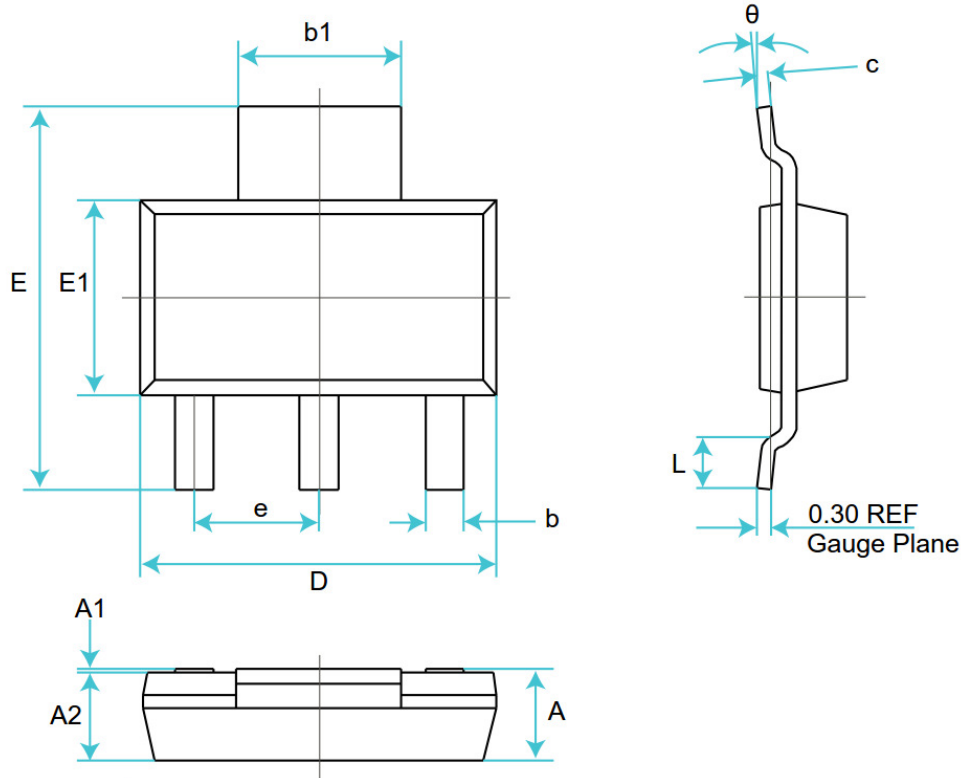
- B1117A2= LB1117AACA150
- B1117A3= LB1117AACA180
- B1117A4= LB1117AACA250
- B1117A5= LB1117AACA330
- B1117A6= LB1117AACA500
- B1117A7= LB1117AACAADJ

2) YWWUZ = Date Code & Internal Code

- Y = Year
- WW = Week
- UZ = Internal Code

**Mechanical Information**

(1) Package type: SOT223-3L

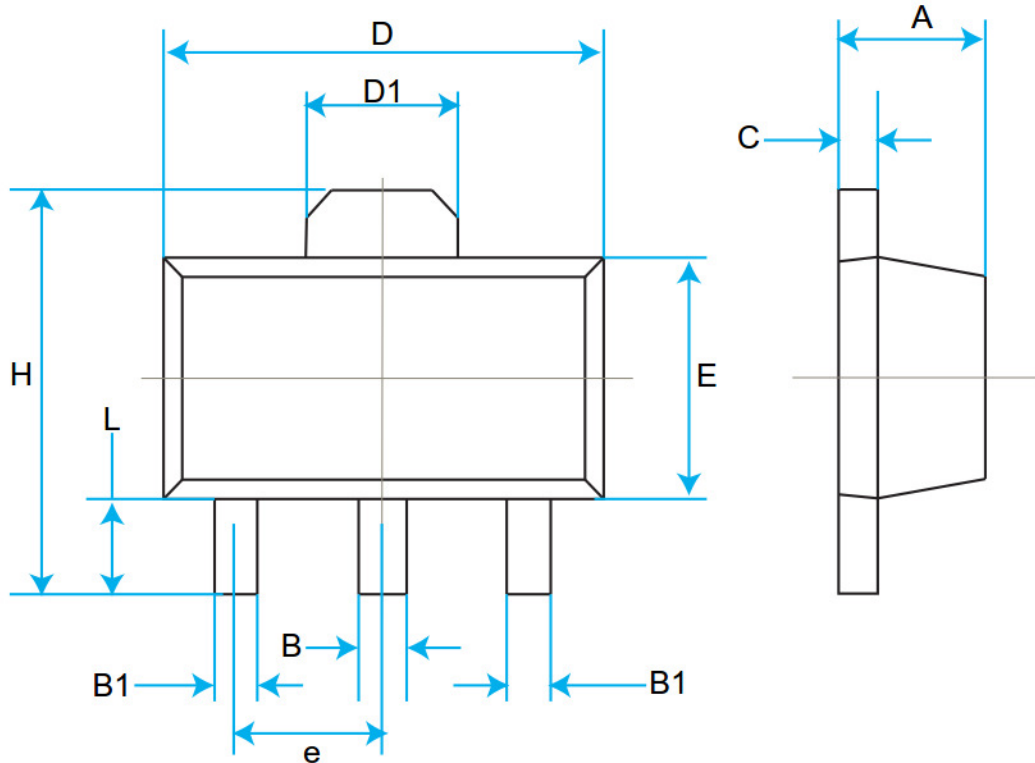


Unit: mm

Symbol	Min	Max
A	-	1.80
A1	0.20	0.10
A2	1.45	1.75
b	0.66	0.84
c	0.23	0.35
D	6.30	6.70
b1	2.90	3.10
E	6.70	7.30
E1	3.30	3.70
e	2.30 BSC	
L	0.75	-
θ	0°	10°

**Mechanical Information (Contd.)**

(2) Package type: SOT89-3L

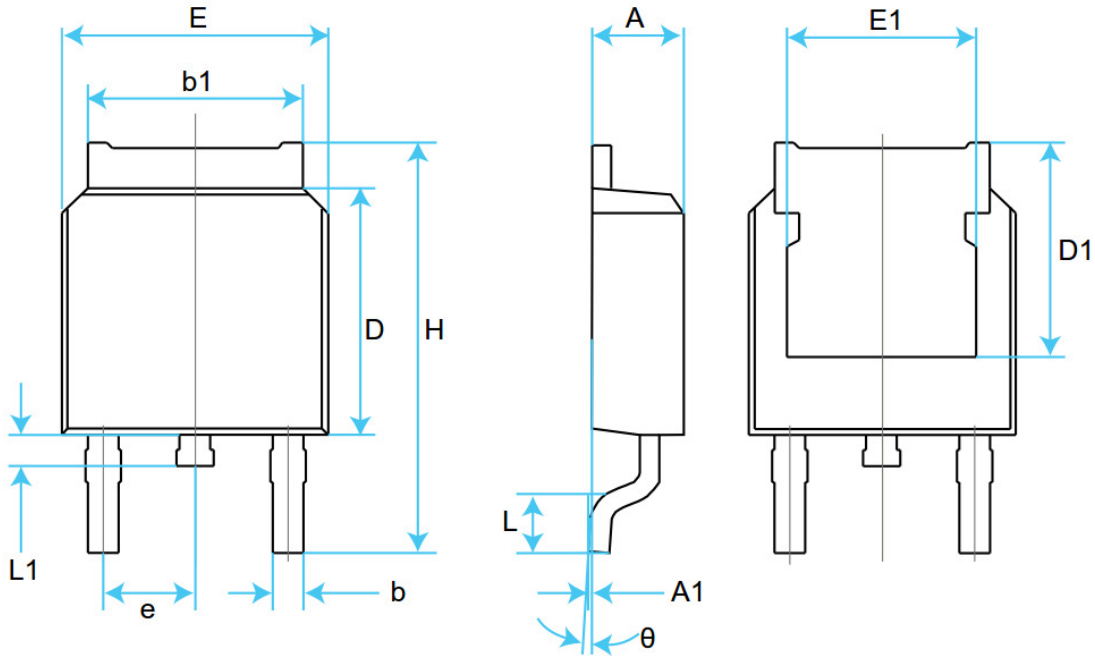


Unit: mm

Symbol	Min	Max
A	1.40	1.60
B	0.40	0.58
B1	0.32	0.52
C	0.35	0.46
D	4.30	4.70
D1	1.70 REF	
E	2.30	2.70
e	1.50 TYP	
H	3.94	4.70
L	0.80	1.20

**Mechanical Information (Contd.)**

(3) Package type: TO252-2L



Unit: mm

Symbol	Min	Max
A	2.200	2.400
A1	-	0.127
b	0.660	0.860
b1	5.334 REF	
D	6.000	6.200
D1	5.300 REF	
E	6.500	6.700
E1	4.830 REF	
e	2.286 BSC	
H	9.800	10.400
L	1.400	1.700
L1	0.600	1.000
$\theta$	0°	8°

**MSL (Moisture Sensitive Level) Information**

**IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Levels Table**

LEVEL	FLOOR LIFE		SOAK REQUIREMENTS				
			Standard		Accelerated Equivalent <sup>1</sup>		CONDITION
	TIME	CONDITION			TIME (hours)	CONDITION	
1	Unlimited	≤30 °C /85% RH	168 +5/-0	85 °C /85% RH	NA	NA	NA
2	1 year	≤30 °C /60% RH	168 +5/-0	85 °C /60% RH	NA	NA	NA
2a	4 weeks	≤30 °C /60% RH	696 <sup>2</sup> +5/-0	30 °C /60% RH	120 -1/+0	168 -1/+0	60 °C/ 60% RH
3	168 hours	≤30 °C /60% RH	192 <sup>2</sup> +5/-0	30 °C /60% RH	40 -1/+0	52 -1/+0	60 °C/ 60% RH
4	72 hours	≤30 °C /60% RH	96 <sup>2</sup> +2/-0	30 °C /60% RH	20 +0.5/-0	24 +0.5/-0	60 °C/ 60% RH
5	48 hours	≤30 °C /60% RH	72 <sup>2</sup> +2/-0	30 °C /60% RH	15 +0.5/-0	20 +0.5/-0	60 °C/ 60% RH
a	24 hours	≤30 °C /60% RH	48 <sup>2</sup> +2/-0	30 °C /60% RH	10 +0.5/-0	13 +0.5/-0	60 °C/ 60% RH
6	Time on Label (TOL)	≤30 °C /60% RH	TOL	30 °C /60% RH	NA	NA	NA

**Note 1:** CAUTION - To use the “accelerated equivalent” soak conditions, correlation of damage response (including electrical, after soak and reflow), should be established with the “standard” soak conditions. Alternatively, if the known activation energy for moisture diffusion of the package materials is in the range of 0.40 - 0.48 eV or 0.30 - 0.39 eV, the “accelerated equivalent” may be used. Accelerated soak times may vary due to material properties (e.g .mold compound, encapsulant, etc.). JEDEC document JESD22-A120 provides a method for determining the diffusion coefficient.

**Note 2:** The standard soak time includes a default value of 24 hours for semiconductor manufacturer’s exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor’s facility. If the actual MET is less than 24 hours the soak time may be reduced. For soak conditions of 30 °C/60% RH, the soak time is reduced by 1 hour for each hour the MET is less than 24 hours. For soak conditions of 60 °C/60% RH, the soak time is reduced by 1 hour for each 5 hours the MET is less than 24 hours. If the actual MET is greater than 24 hours the soak time must be increased. If soak conditions are 30 °C/60% RH, the soak time is increased 1 hour for each hour that the actual MET exceeds 24 hours. If soak conditions are 60 °C/60% RH, the soak time is increased 1 hour for each 5 hours that the actual MET exceeds 24 hours.

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